

[illegible]

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled PROCESS FOR FORMING AGGREGATES OF HYDROPHOBIC GROUP-CONTAINING POLYSACCHARIDE, the

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Priority  
Claimed

(Number)	(Country)	(Day/Month/Year Filed)	Yes	No
(Number)	(Country)	(Day/Month/Year Filed)	Yes	No
(Number)	(Country)	(Day/Month/Year Filed)	Yes	No

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
--------------------------	---------------	--

(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
1000000	1950	patented
1000001	1951	pending
1000002	1952	abandoned

As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith:

5 Dale H. Thiel (Reg. No. 24 323), David G. Boutell (Reg. No. 25 072), Ronald J. Tanis (Reg. No. 22 724), Terryence F. Chapman (Reg. No. 32 549) and Mark L. Maki (Reg. No. 36 589).

Send correspondence to:  
FLYNN, THIEL, BOUTELL & TANIS, P.C.  
2026 Rambling Road  
Kalamazoo, Michigan 49008-1699

Direct telephone calls to:  
(616) 381-1156

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

100 Full name of sole or first inventor Ryuzo HOSOTANI

Inventor's signature Ryuzo Hosotani October 30, 2000  
 Date

Residence Nishinomiya-Shi, Hyogo, Japan JPN

Citizenship Japan

Post Office Address 1-13, Higashinaruo-Cho 1-Chome, Nishinomiya-Shi, Hyogo  
663-8132, Japan

200 Full name of second joint inventor, if any Akio HAYASHI

Inventor's signature Akio Hayashi November 2, 2000  
 Date

Residence Adachi-Ku, Tokyo, Japan JPN

Citizenship Japan

Post Office Address 12-12, Kahei 3-Chome, Adachi-Ku, Tokyo 121-0055, Japan

300 Full name of third joint inventor, if any Yoshio NAKANO

Inventor's signature Yoshio Nakano October 31, 2000  
 Date

Residence Tsukuba-Shi, Ibaraki, Japan JPN

Citizenship Japan

Post Office Address 15-5, Umezono 2-Chome, Tsukuba-Shi, Ibaraki 305-0045, Japan

(Supply similar information and signature for fourth and subsequent joint inventors.)